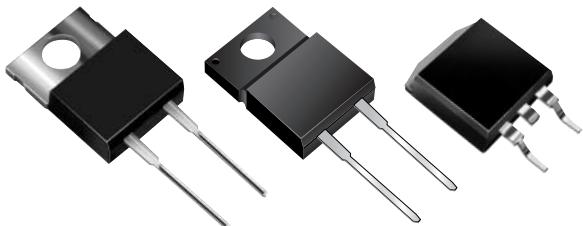
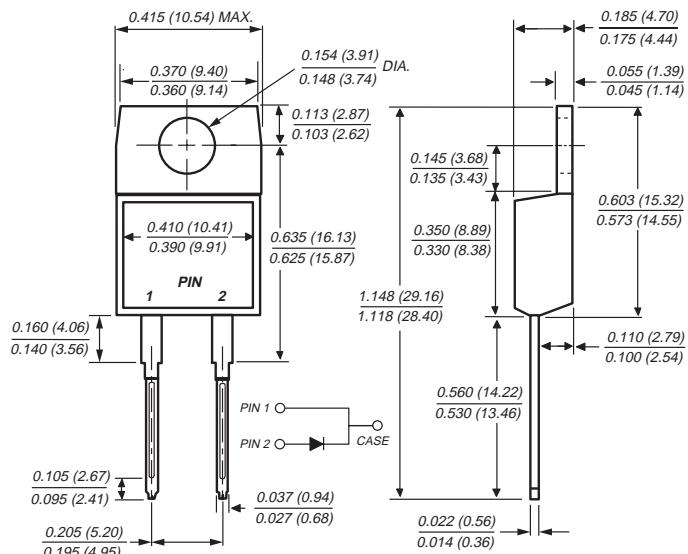
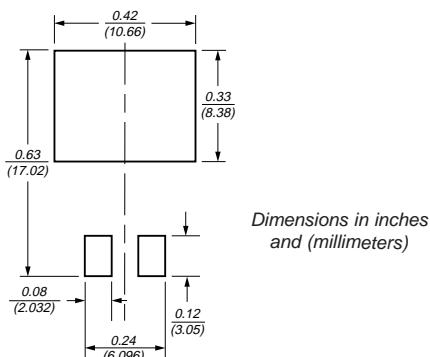


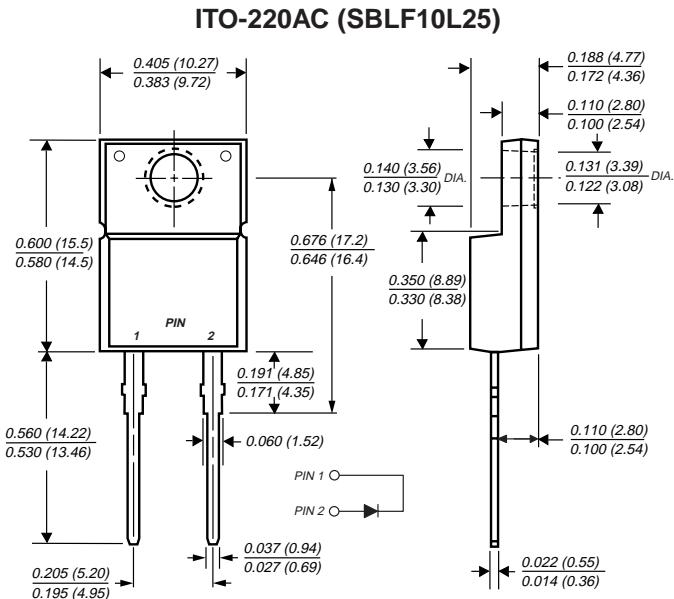
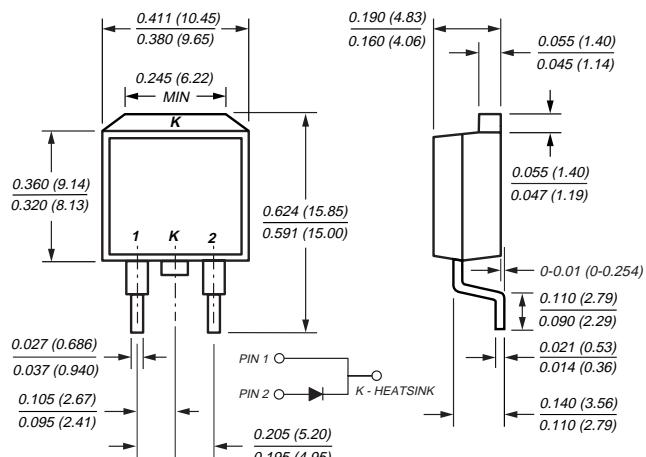
Low VF Schottky Barrier Rectifier


 Reverse Voltage 25V
 Forward Current 10A

TO-220AC (SBL10L25)

Mounting Pad Layout TO-263AB


Features

- Plastic package has Underwriters Laboratory Flammability Classification 94V-0
- Dual rectifier construction, positive center tap
- Metal silicon junction, majority carrier conduction
- Low power loss, high efficiency
- Guardring for overvoltage protection
- For use in low voltage, high frequency inverters, free wheeling, and polarity protection applications


TO-263AB (SBLB10L25)


Mechanical Data

Case: JEDEC TO-220AC, ITO-220AC & TO-263AB molded plastic body

Terminals: Plated leads, solderable per MIL-STD-750, Method 2026

High temperature soldering guaranteed:
250°C/10 seconds, at terminals

Polarity: As marked

Mounting Position: Any

Mounting Torque: 10 in-lbs maximum

Weight: 0.08 oz., 2.24 g

SBL10L25, SBLF10L25 & SBLB10L25



Vishay Semiconductors
formerly General Semiconductor

Maximum Ratings (T_C = 25°C unless otherwise noted)

Parameter	Symbol	SBL10L25	Unit
Maximum repetitive peak reverse voltage	V _{RRM}	25	V
Working peak reverse voltage	V _{RWM}	18	V
Maximum DC blocking voltage	V _{DC}	25	V
Maximum average forward rectified current at T _C = 135°C	I _{F(AV)}	10	A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I _{FSM}	240	A
Peak repetitive reverse current at t _p = 2μs, 1kHz	I _{RRM}	1.0	A
Voltage rate of change (rated V _R)	dv / dt	10,000	V / μs
Operating junction and storage temperature range	T _J , T _{TSG}	-65 to +150	°C
RMS Isolation voltage (SBLF type only) from terminals to heatsink with t = 1 second, RH ≤ 30%	V _{ISOL}	4500 ⁽¹⁾ 3500 ⁽²⁾ 1500 ⁽³⁾	V

Electrical Characteristics (T_C = 25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Maximum instantaneous forward voltage ⁽⁴⁾	V _F	0.46 0.35 0.55 0.48	V
Maximum instantaneous reverse current at DC blocking voltage ⁽⁴⁾	I _R	0.80 260	mA

Thermal Characteristics (T_C = 25°C unless otherwise noted)

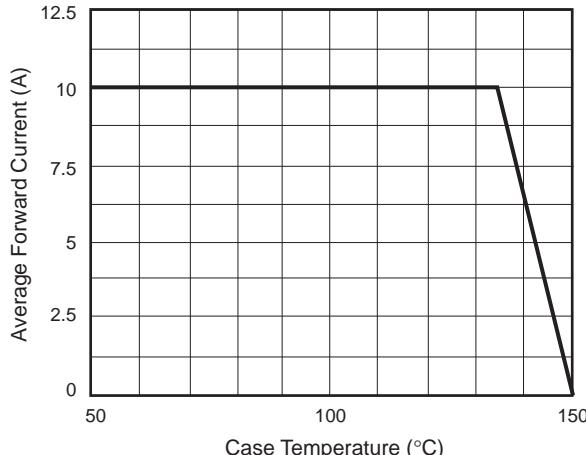
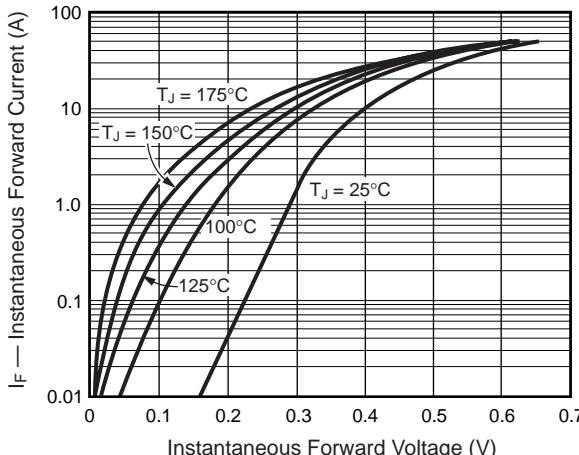
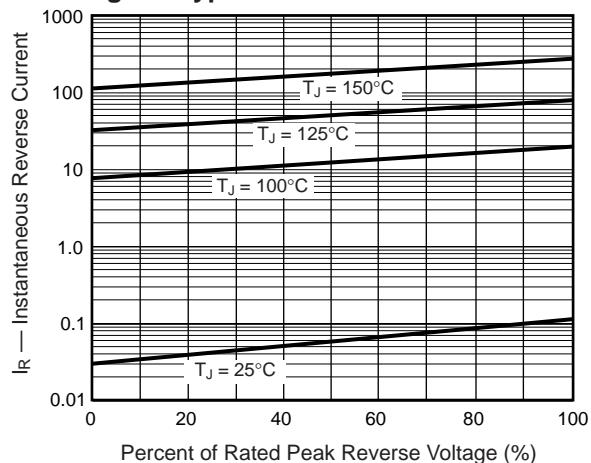
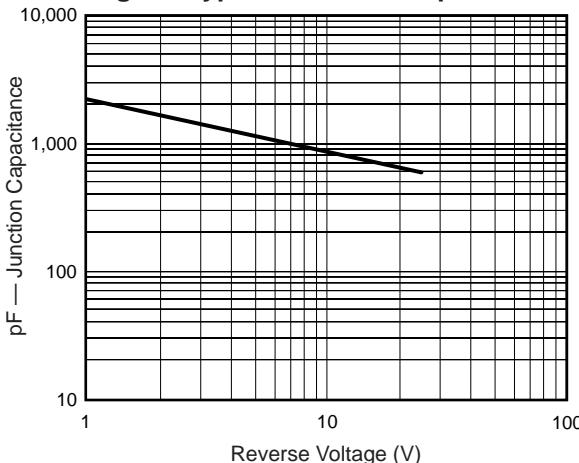
Parameter	Symbol	SBL	SBLF	SBLB	Unit
Typical thermal resistance from junction to case per leg	R _{θJC}	1.5	4.0	1.5	°C/W

Notes:

- (1) Clip mounting (on case), where lead does not overlap heatsink with 0.110" offset
- (2) Clip mounting (on case), where leads do overlap heatsink
- (3) Screw mounting with 4-40 screw, where washer diameter is ≤ 4.9 mm (0.19")
- (4) Pulse test: 380μs pulse width, 2% duty cycle

Ordering Information

Part Number	Case	Package Code	Package Option
SBL10L25	TO-220AC	45	Anti-static tube pack, 50/tube, 2K/carton
SBLF10L25	ITO-220AC	45	Anti-static tube pack, 50/tube, 2K/carton
SBLB10L25	TO-263AB	45 31 81	Anti-static tube pack, 50/tube, 2K/carton 13" tape/reel, 800/reel, 4.8K/carton Anti-static 13" tape/reel, 800/reel, 4.8K/carton

**Ratings and
Characteristic Curves** ($T_A = 25^\circ\text{C}$ unless otherwise noted)**Fig. 1 – Forward Current
Derating Curve****Fig. 2 – Typical Instantaneous
Forward Characteristics****Fig. 3 – Typical Reverse Characteristics****Fig. 4 – Typical Junction Capacitance****Fig. 5 – Typical Transient
Thermal Impedance**